Product data sheet

1. General description

P-channel enhancement mode MOSFET in an LFPAK56 (Power SO8) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

2. Features and benefits

- High thermal power dissipation capability
- Suitable for thermally demanding environments due to 175 °C rating
- Trench MOSFET technology

3. Applications

- · Reverse battery protection
- · Power management
- · High-side load switch
- · Motor drive

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V_{DS}	drain-source voltage	T _j = 25 °C		-	-	-60	V
V_{GS}	gate-source voltage			-20	-	20	V
I _D	drain current	V _{GS} = -10 V; T _{mb} = 25 °C		-	-	-30	Α
P _{tot}	total power dissipation	T _{mb} = 25 °C		-	-	110	W
Static characteristics							
R _{DSon}	drain-source on-state resistance	$V_{GS} = -10 \text{ V}; I_D = -7 \text{ A}; T_j = 25 \text{ °C}$		-	26	33	mΩ



5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source	mb	D
2	S	source		
3	S	source	a	G (F)
4	G	gate		s
mb	D	mounting base; connected to drain	LFPAK56; Power- SO8 (SOT669)	017aaa094

6. Ordering information

Table 3. Ordering information

Type number	Package					
	Name	Description	Version			
PSMP033-60YE	LFPAK56; Power-SO8	plastic, single-ended surface-mounted package; 4 terminals	SOT669			

7. Marking

Table 4. Marking codes

Type number	Marking code
PSMP033-60YE	03360YE

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	T _j = 25 °C		-	-60	V
V _{GS}	gate-source voltage			-20	20	V
I _D	drain current	V _{GS} = -10 V; T _{mb} = 25 °C		-	-30	Α
		V _{GS} = -10 V; T _{mb} = 100 °C		-	-21	Α
I _{DM}	peak drain current	single pulse; t _p ≤ 10 µs; T _{mb} = 25 °C		-	-120	Α
P _{tot}	total power dissipation	T _{mb} = 25 °C		-	110	W
T _j	junction temperature			-55	175	°C
T _{amb}	ambient temperature			-55	175	°C
T _{stg}	storage temperature			-65	175	°C
Source-drain di	ode		'			
Is	source current	T _{mb} = 25 °C		-	-30	Α
I _{SM}	peak source current	single pulse; t _p ≤ 10 µs; T _{mb} = 25 °C		-	-120	Α
ESD maximum	rating		'	'	'	
V _{ESD}	electrostatic discharge voltage	НВМ	[1]	-	1000	V
Avalanche rugg	edness		'	1	'	
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	T _{j(init)} = 25 °C; I _D = -2.8 A; DUT in avalanche (unclamped)		-	85	mJ

[1] Measured between all pins.

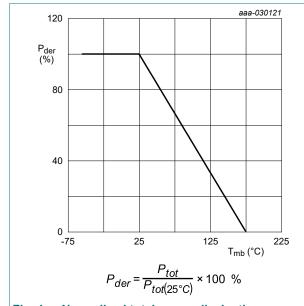


Fig. 1. Normalized total power dissipation as a function of mounting base temperature

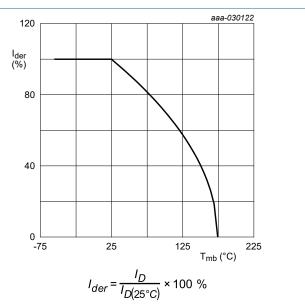


Fig. 2. Normalized continuous drain current as a function of mounting base temperature

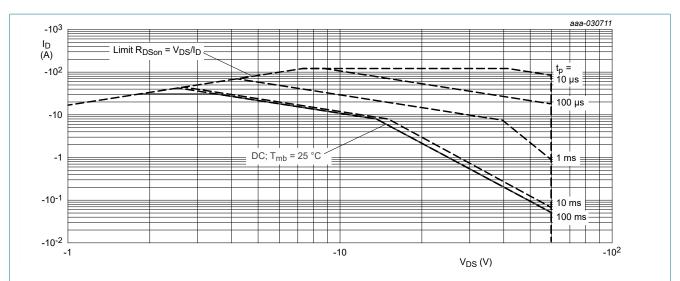


Fig. 3. Safe operating area; junction to mounting base; continuous and peak drain currents as a function of drain-source voltage

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from	in free air	[1]	-	83	91	K/W
juno	unction to ambient		[2]	-	46	51	K/W
R _{th(j-mb)}	thermal resistance from junction to mounting base			-	1.1	1.4	K/W

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.
- Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm².

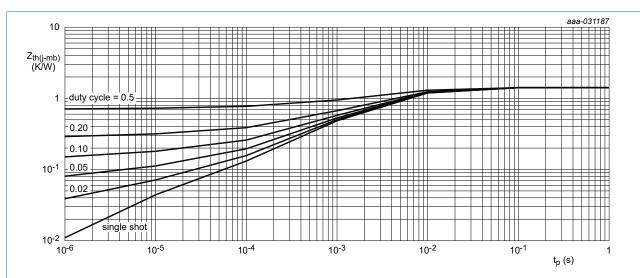


Fig. 4. Transient thermal impedance from junction to mounting base as a function of pulse duration

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics					
V _{(BR)DSS}	drain-source breakdown voltage	$I_D = -250 \mu A; V_{GS} = 0 V; T_j = 25 °C$	-60	-	-	V
V_{GSth}	gate-source threshold voltage	$I_D = -250 \mu A; V_{DS} = V_{GS}; T_j = 25 \text{ °C}$	-1.5	-2	-3	V
I _{DSS}	drain leakage current	V _{DS} = -60 V; V _{GS} = 0 V; T _j = 25 °C	-	-	-1	μΑ
		V _{DS} = -60 V; V _{GS} = 0 V; T _j = 125 °C	-	-	-10	μΑ
I _{GSS}	gate leakage current	V _{GS} = -20 V; V _{DS} = 0 V; T _j = 25 °C	-	-	-100	nA
		V _{GS} = 20 V; V _{DS} = 0 V; T _j = 25 °C	-	-	100	nA
R _{DSon}	drain-source on-state	$V_{GS} = -10 \text{ V}; I_D = -7 \text{ A}; T_j = 25 ^{\circ}\text{C}$	-	26	33	mΩ
	resistance	V _{GS} = -10 V; I _D = -7 A; T _j = 175 °C	-	55	69	mΩ
		V _{GS} = -4.5 V; I _D = -6.7 A; T _j = 25 °C	-	30	36	mΩ
g _{fs}	forward transconductance	$V_{DS} = -10 \text{ V}; I_D = -4.8 \text{ A}; T_j = 25 \text{ °C}$	-	99	-	S
R_G	gate resistance	f = 1 MHz	-	6.1	-	Ω
Dynamic ch	naracteristics					
Q _{G(tot)}	total gate charge	V _{DS} = -30 V; I _D = -7 A; V _{GS} = -10 V;	-	46	69	nC
Q _{GS}	gate-source charge	T _j = 25 °C	-	7.3	-	nC
Q _{GD}	gate-drain charge		-	9.4	-	nC
C _{iss}	input capacitance	V _{DS} = -30 V; f = 1 MHz; V _{GS} = 0 V;	-	2590	-	pF
C _{oss}	output capacitance	T _j = 25 °C	-	202	-	pF
C _{rss}	reverse transfer capacitance		-	118	-	pF
d(on)	turn-on delay time	$V_{DS} = -30 \text{ V}; I_D = -7 \text{ A}; V_{GS} = -10 \text{ V};$	-	9	-	ns
t _r	rise time	$R_{G(ext)} = 6 \Omega; T_j = 25 ^{\circ}C$	-	16	-	ns
t _{d(off)}	turn-off delay time]	-	81	-	ns
t _f	fall time]	-	310	-	ns
Source-drai	in diode		'			
V_{SD}	source-drain voltage	$I_S = -30 \text{ A}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	-0.7	-1.2	V
t _{rr}	reverse recovery time	$I_S = -30 \text{ A}; dI_S/dt = 100 \text{ A/}\mu\text{s};$	-	32	-	ns
Q _r	recovered charge	$V_{GS} = -10 \text{ V}; V_{DS} = -30 \text{ V}; T_j = 25 \text{ °C}$	-	18	-	nC

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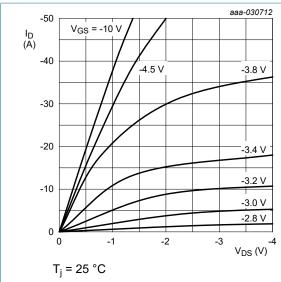


Fig. 5. Output characteristics: drain current as a function of drain-source voltage; typical values

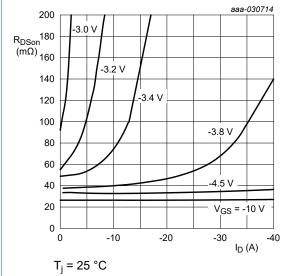


Fig. 7. Drain-source on-state resistance as a function of drain current; typical values

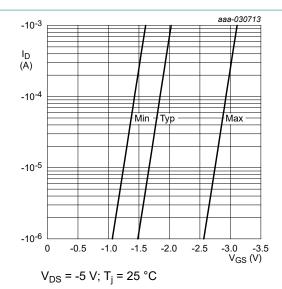


Fig. 6. Sub-threshold drain current as a function of gate-source voltage

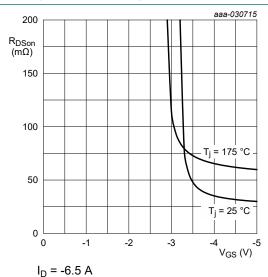


Fig. 8. Drain-source on-state resistance as a function of gate-source voltage; typical values

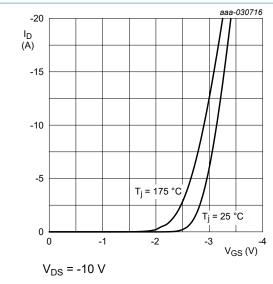


Fig. 9. Transfer characteristics: drain current as a function of gate-source voltage; typical values

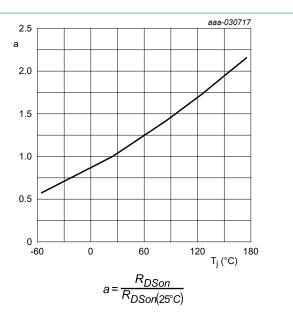


Fig. 10. Normalized drain-source on-state resistance as a function of junction temperature; typical values

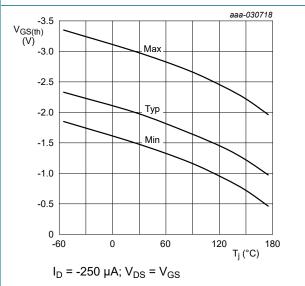
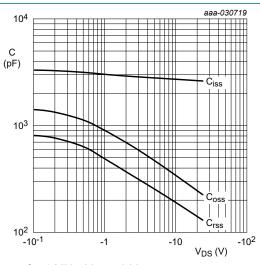


Fig. 11. Gate-source threshold voltage as a function of junction temperature



 $f = 1 MHz; V_{GS} = 0 V$

Fig. 12. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

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60 V, P-channel Trench MOSFET

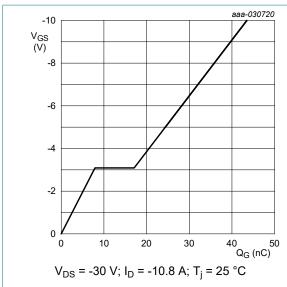


Fig. 13. Gate-source voltage as a function of gate charge; typical values

 $V_{GS} = 0 V$

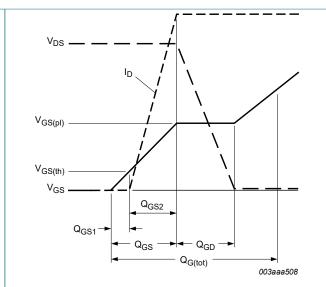


Fig. 14. Gate charge waveform definitions

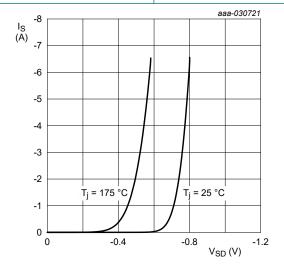
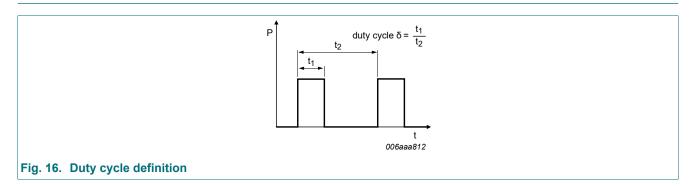


Fig. 15. Source current as a function of source-drain voltage; typical values

11. Test information



12. Package outline

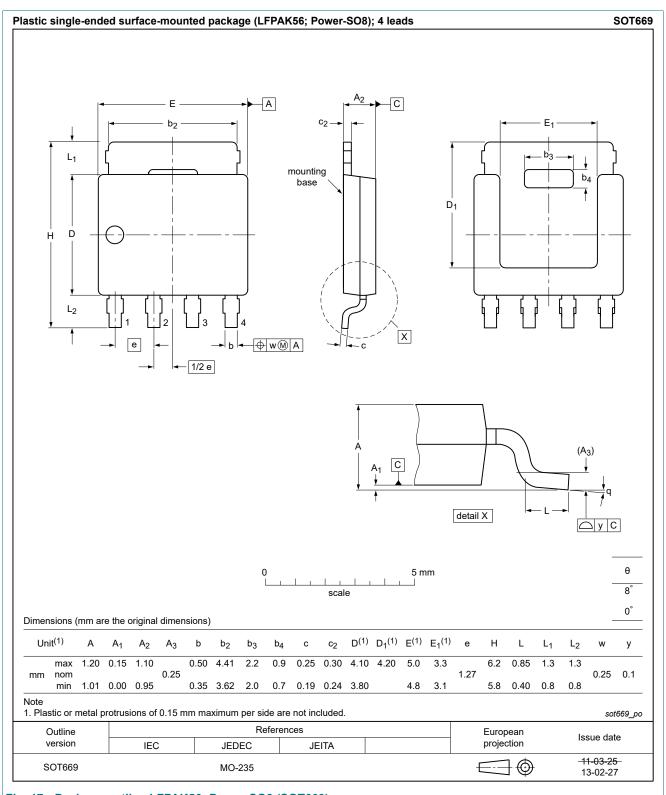
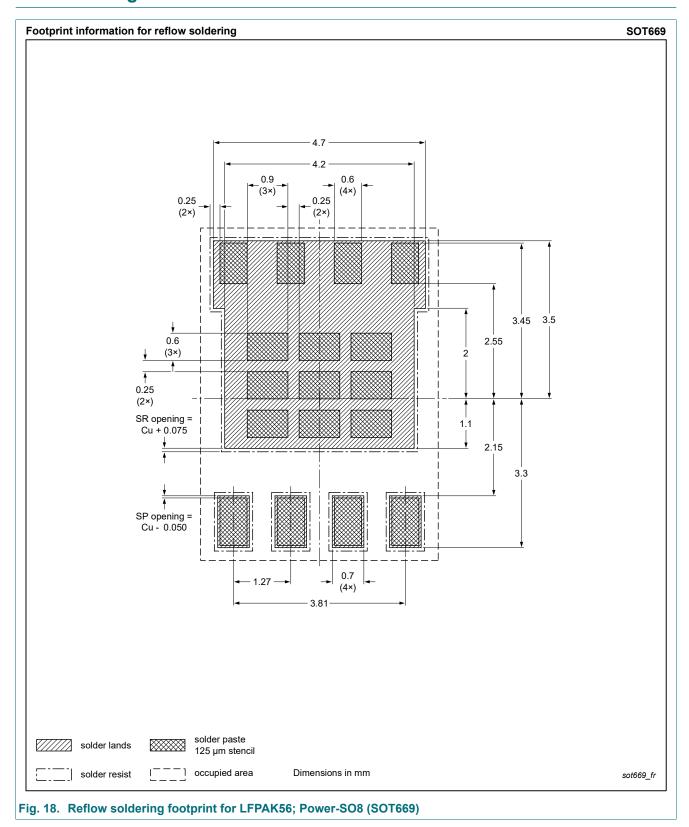


Fig. 17. Package outline LFPAK56; Power-SO8 (SOT669)

13. Soldering



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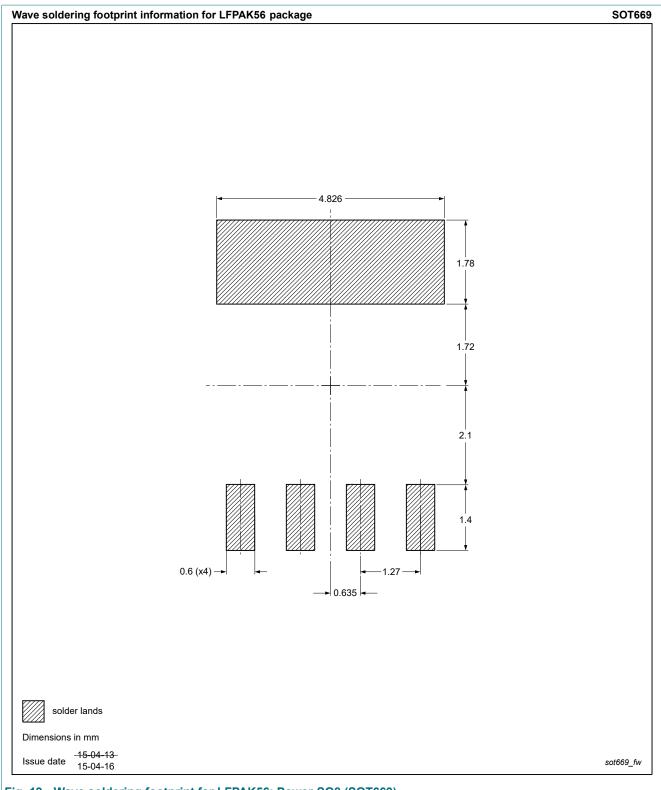


Fig. 19. Wave soldering footprint for LFPAK56; Power-SO8 (SOT669)

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PSMP033-60YE v.1	20210113	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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